May 2014



FDBL9406\_F085

# N-Channel PowerTrench<sup>®</sup> MOSFET 40 V, 240 A, 1.2 m $\Omega$

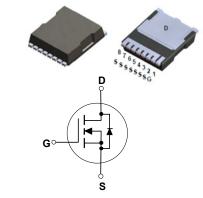
#### **Features**

- Typical  $R_{DS(on)}$  = 0.9 m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- Typical  $Q_{q(tot)}$  = 90 nC at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### **Applications**

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems





For current package drawing, please refer to the Fairchild website at http://www.fairchildsemi.com/dwg/PS/PSOF08A.pdf.

#### **MOSFET Maximum Ratings** T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-to-Source Voltage		40	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
ı	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> = 25°C	240	^
ID	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	316	mJ
D	Power Dissipation		300	W
$P_D$	Derate Above 25°C		2.0	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.5	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W

#### Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25^{\circ}C$ , L = 0.1mH,  $I_{AS} = 79.5$ A,  $V_{DD} = 40$ V during inductor charging and  $V_{DD} = 0$ V during time in avalanche.
- 3: R<sub>0,JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,JC</sub> is guaranteed by design, while R<sub>0,JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

#### **Package Marking and Ordering Information**

Device Marking	Device	Package			
FDBL9406	FDBL9406_F085	MO-299A	-	-	-

Max.

Тур.

Min.

Units

## **Electrical Characteristics** $T_J = 25^{\circ}C$ unless otherwise noted.

**Parameter** 

Off Characteristics							
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = 250 \mu A$ ,	V <sub>GS</sub> = 0V	40	-	-	V
	I Design to Course Leglage Courset	V <sub>DS</sub> =40V,	$T_{\rm J} = 25^{\rm o}{\rm C}$	-	-	1	μΑ
I <sub>DSS</sub> Drain-to-Source Leakage Current	$V_{GS} = 0V$	$T_J = 175^{\circ}C \text{ (Note 4)}$	-	-	1	mA	
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$	,	-	-	±100	nA

**Test Conditions** 

#### **On Characteristics**

Symbol

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , I	<sub>D</sub> = 250μA	2.0	3.2	4.0	٧
D	R <sub>50</sub> () Drain to Source On Resistance	I <sub>D</sub> = 80A,	$T_{J} = 25^{\circ}C$	-	0.90	1.20	$m\Omega$
DS(on)		V <sub>GS</sub> = 10V	$T_J = 175^{\circ}C \text{ (Note 4)}$	ı	1.64	1.86	mΩ

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	251/1/		-	7735	-	pF
C <sub>oss</sub>	Output Capacitance		$-V_{DS} = 25V, V_{GS} = 0V,$ - f = 1MHz		2160	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	I - TIVILIZ			129	-	pF
$R_g$	Gate Resistance	f = 1MHz		-	2.5	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	V <sub>DD</sub> = 32V	-	90	107	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0$ to 2V	I <sub>D</sub> = 80A	-	13.5	15.5	nC
$Q_{gs}$	Gate-to-Source Gate Charge		_	-	43	-	nC
$Q_{gd}$	Gate-to-Drain "Miller" Charge			-	10	-	nC

### **Switching Characteristics**

$t_{on}$	Turn-On Time		-	-	102	ns
t <sub>d(on)</sub>	Turn-On Delay		-	33	-	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 20V, I <sub>D</sub> = 80A,	-	40	-	ns
t <sub>d(off)</sub>	Turn-Off Delay	$V_{GS}$ = 10V, $R_{GEN}$ = $6\Omega$	-	47	-	ns
t <sub>f</sub>	Fall Time		-	23	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	91	ns

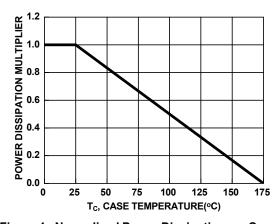
#### **Drain-Source Diode Characteristics**

V	Source-to-Drain Diode Voltage	I <sub>SD</sub> =80A, V <sub>GS</sub> = 0V	-	-	1.25	V
$V_{SD}$	Source-to-Drain blode voltage	$I_{SD} = 40A, V_{GS} = 0V$	-	-	1.2	V
t <sub>rr</sub>	Reverse-Recovery Time	I <sub>F</sub> = 80A, dI <sub>SD</sub> /dt = 100A/μs,	-	91	107	ns
Q <sub>rr</sub>	Reverse-Recovery Charge	V <sub>DD</sub> =32V	-	128	167	nC

#### Note:

4: The maximum value is specified by design at  $T_J$  = 175°C. Product is not tested to this condition in production.

## **Typical Characteristics**



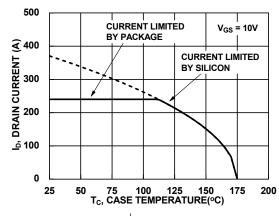
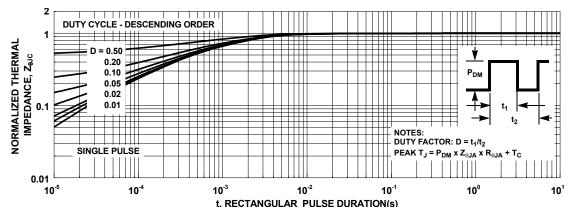


Figure 1. Normalized Power Dissipation vs. Case Temperature

Figure 2. Maximum Continuous Drain Current vs. Case Temperature



t, RECTANGULAR PULSE DURATION(s)
Figure 3. Normalized Maximum Transient Thermal Impedance

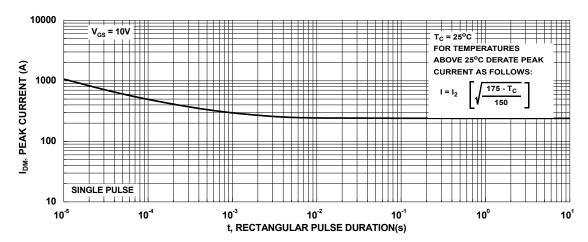


Figure 4. Peak Current Capability

## **Typical Characteristics**

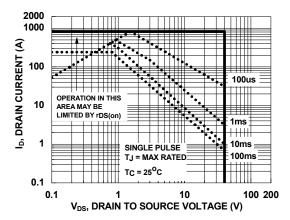
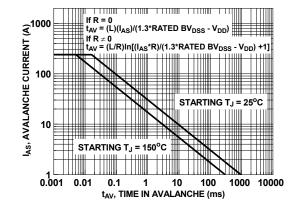


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

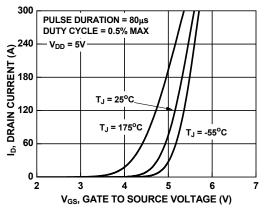


Figure 7. Transfer Characteristics

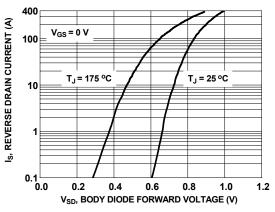


Figure 8. Forward Diode Characteristics

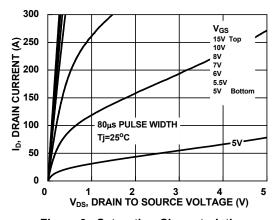


Figure 9. Saturation Characteristics

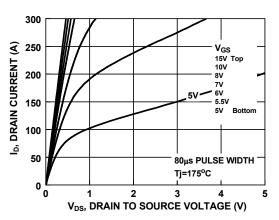


Figure 10. Saturation Characteristics

## **Typical Characteristics**

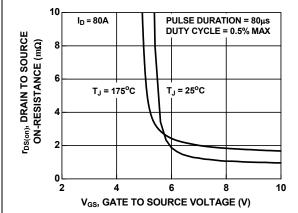


Figure 11. R<sub>DSON</sub> vs. Gate Voltage

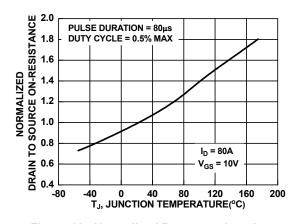


Figure 12. Normalized R<sub>DSON</sub> vs. Junction Temperature

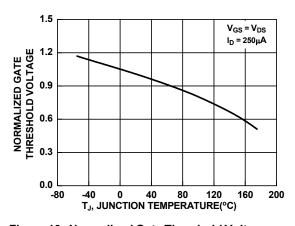


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

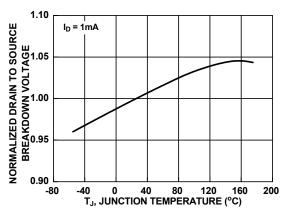


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

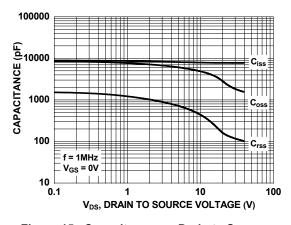


Figure 15. Capacitance vs. Drain to Source Voltage

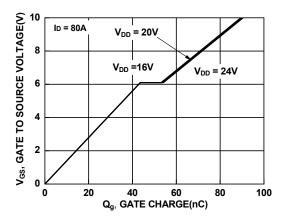


Figure 16. Gate Charge vs. Gate to Source Voltage





#### **TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™
AX-CAP®\*
BitSiC™
Build it Now™
CorePLUS™

CorePLUS™ CorePOWER™ CROSSVOLT™ CTL™

Current Transfer Logic™
DEUXPEED®
Dual Cool™
EcoSPARK®
EfficentMax™
ESBC™

Fairchild<sup>®</sup>
Fairchild Semiconductor<sup>®</sup>
FACT Quiet Series<sup>™</sup>
FACT<sup>®</sup>
FAST<sup>®</sup>
FastvCore<sup>™</sup>
FETBench<sup>™</sup>

F-PFS™ FRFET®

Global Power Resource<sup>SM</sup> GreenBridge<sup>™</sup>

Green FPS™

Green FPS™ e-Series™

Gmax<sup>™</sup> GTO<sup>™</sup> IntelliMAX<sup>™</sup> ISOPLANAR<sup>™</sup>

Marking Small Speakers Sound Louder and Better  $^{\text{TM}}$ 

Marking Small Speak and Better™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™

MillerDrive™ MotionMax™ mWSaver® OptoHiT™ OPTOLOGIC® OPTOPLANAR® ® PowerTrench® PowerXS™

Programmable Active Droop<sup>TM</sup> QFET<sup>®</sup>

QFET<sup>®</sup>
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™

SMART START™ Solutions for Your Success™

SPM<sup>®</sup>
STEALTH™
SuperFET<sup>®</sup>
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8

SupreMOS<sup>®</sup>
SyncFET™
Sync-Lock™

SYSTEM ®\*

GENERAL

TinyBoost®

TinyBuck®

TinyCalc™

TinyGalc<sup>TM</sup>
TinyCagic<sup>®</sup>
TINYOPTO<sup>TM</sup>
TinyPower<sup>TM</sup>
TinyPWM<sup>TM</sup>
TinyWire<sup>TM</sup>
TranSiC<sup>TM</sup>

TriFault Detect™
TRUECURRENT®\*
μSerDes™

₩ Ser<sub>De</sub>

UHC<sup>®</sup>
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™
仏童™

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FPS™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are
  intended for surgical implant into the body or (b) support or sustain life,
  and (c) whose failure to perform when properly used in accordance with
  instructions for use provided in the labeling, can be reasonably
  expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors

## PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 168

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor:

FDBL9406\_F085